# LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

# Winstar Display Co., LTD 華凌光電股份有限公司



WEB: <a href="https://www.winstar.com.tw">https://www.winstar.com.tw</a> E-mail: sales@winstar.com.tw

### **SPECIFICATION**

MODULE NO.: _	WG320240A-TFH-VZ#
CUSTOMER :	<u> </u>

APPROVED BY:		
FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
15			

VERSION	DATE	REVISED	SUMMARY		
		PAGE NO.			
P	2023/12/26		Modify Backlight	Frame	and



MODLE NO:

華凌光電股份有限公司

### **RECORDS OF REVISION**

DOC. FIRST ISSUE

		,	
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2006/02/27		First issue
A	2006/07/03		Modify VDD=3.3/5.0V
В	2006/09/12		Modify Luminous Intensity
С	2008/02/01		Modify contour drawing.
D	2008/10/17		Modify Backlight
			information
E	2012/02/20	40	Modify Backlight
			information
F	2014/08/12		Remove IC information
			Correct VDD-Vo &
			Response Time
G	2016/01/15		Modify Absolute
			Maximum Ratings.
H	2016/01/27		Modify Precautions in use
			of LCD Modules & Length
			of cable & Static electricity
			test
I	2017/02/03		Modify Backlight
			Information

J	2019/08/27	Modify Material List of Components for RoHs
K	2019/12/17	Modify Precautions in use of LCD Modules
L	2020/07/22	Modify B/L information
M	2021/03/16	Modify B/L information
N	2022/11/16	Modify Backlight Information(Note)
О	2023/03/07	Modify Contour drawing & Pin7=NC
P	2023/12/26	Modify Frame and Backlight.

### **Contents**

- 1.Module Classification Information
- 2. Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

### 1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 320 \* 240 dot

Model serials no.

 $\bigcirc$  Backlight Type: N $\rightarrow$ Without backlight T $\rightarrow$ LED, White L $\rightarrow$ LED, Full color

 $B\rightarrow EL$ , Blue green  $A\rightarrow LED$ , Amber  $J\rightarrow DIP$  LED, Blue  $D\rightarrow EL$ , Green  $R\rightarrow LED$ , Red  $K\rightarrow DIP$  LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow EL$ , Yellow Green  $G\rightarrow LED$ , Green  $H\rightarrow DIP$  LED, Amber  $F\rightarrow CCFL$ , White  $P\rightarrow LED$ , Blue  $I\rightarrow DIP$  LED, Red

 $Y\rightarrow$ LED, Yellow Green  $X\rightarrow$ LED, Dual color  $G\rightarrow$ LED, Green  $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$  Positive, Gray  $F \rightarrow FSTN$  Positive  $I \rightarrow HTN$  Negative, Black  $K \rightarrow FSC$  Negative  $U \rightarrow HTN$  Negative, Blue  $S \rightarrow FSC$  Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00 direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E $\rightarrow$ Transflective, N.T.12:00 L $\rightarrow$ Transmissive, W.T,12:00

Special Code
V : Built in negative voltage

Z:IC NT7086

#:Fit in with the ROHS Directions and regulations

### 2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

# **3.General Specification**

Item	Dimension	Unit
Number of dots	320 x 240	_
Module dimension	160.0 x 109.0 x 13.0 (MAX)	mm
View area	122.0 x 92.0	mm
Active area	115.18 x 86.38	mm
Dot size	0.34 x 0.34	mm
Dot pitch	0.36 x 0.36	mm
LCD type	FSTN Positive Transflective  (In LCD production, It will occur slightly color of can only guarantee the same color in the same based on the same based of the same based of the same based on th	
Duty	1/240	
View direction	6 o'clock	
Backlight Type	LED White	

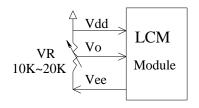
# **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ST}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input voltage	$V_{ m IN}$	-0.3	_	V <sub>DD</sub> +0.3	V
Supply Voltage For Logic	$V_{ m DD} ext{-}V_{ m SS}$	-0.3	_	7.0	V
Supply Voltage For LCD	$V_{DD}$ - $V_0$	0	_	30	V

# **5.Electrical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	_	2.7	_	5.5	V
		Ta=-20°C	_	_	26.2	V
Supply Voltage For LCD *Note	$ m V_{DD} ext{-}V_0$	Ta=25°C	23.0	23.6	24.2	V
· Note		Ta=+70°C	22.1	_	(	V
Input High Volt.	$ m V_{IH}$	_	$0.8V_{\mathrm{DD}}$	_	$V_{DD}$	V
Input Low Volt.	$V_{IL}$	_	0	<b>^−</b> C	$0.2V_{\mathrm{DD}}$	V
Output High Volt.	$ m V_{OH}$	_	V <sub>DD</sub> -0.4		_	V
Output Low Volt.	$V_{\mathrm{OL}}$	-	H	_	0.4	V
Supply Current	$I_{DD}$	7	60.0	75.0	80.0	mA

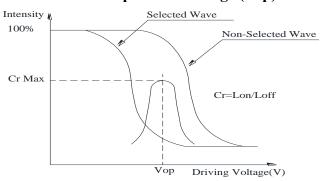
<sup>\*</sup>Note: Please design the VOP adjustment circuit on customer's main board



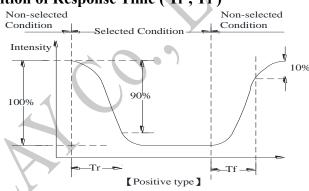
## **6.Optical Characteristics**

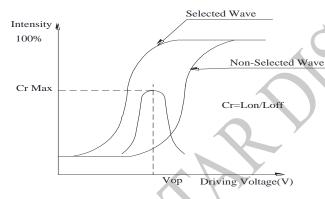
Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	θ	CR≧2	0	_	30	$\phi = 180^{\circ}$
	θ	CR≧2	0	_	60	$\phi = 0^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
Response Time	T rise	_	—	200	300	ms
	T fall	_	_	250	350	ms

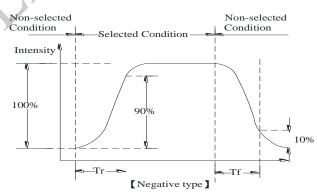
#### **Definition of Operation Voltage (Vop)**



#### **Definition of Response Time (Tr, Tf)**







#### **Conditions:**

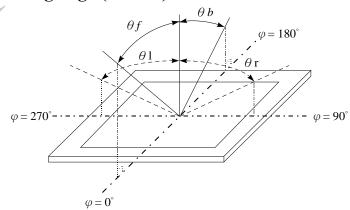
Operating Voltage: Vop

Viewing Angle( $\theta$ ,  $\varphi$ ):  $0^{\circ}$ ,  $0^{\circ}$ 

Frame Frequency: 64 HZ

Driving Waveform: 1/N duty, 1/a bias

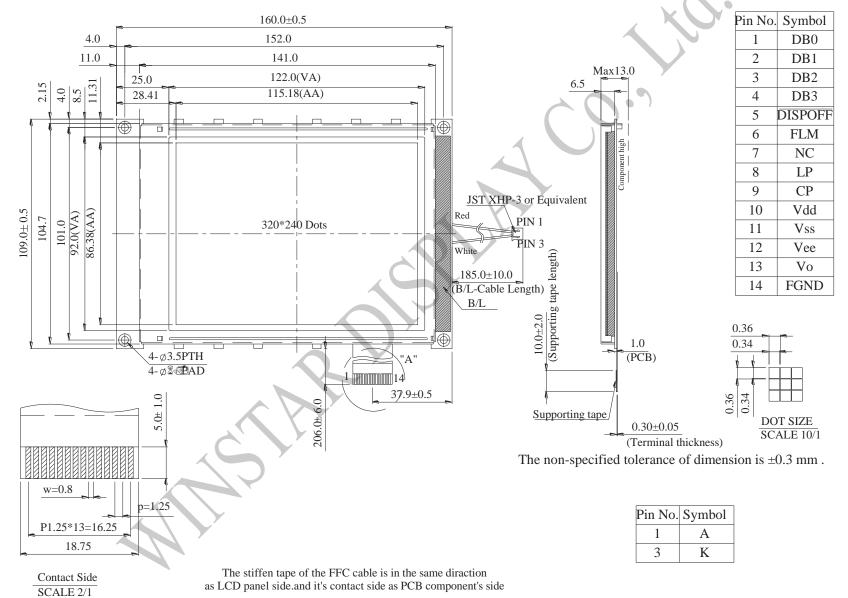
#### Definition of viewing angle( $CR \ge 2$ )

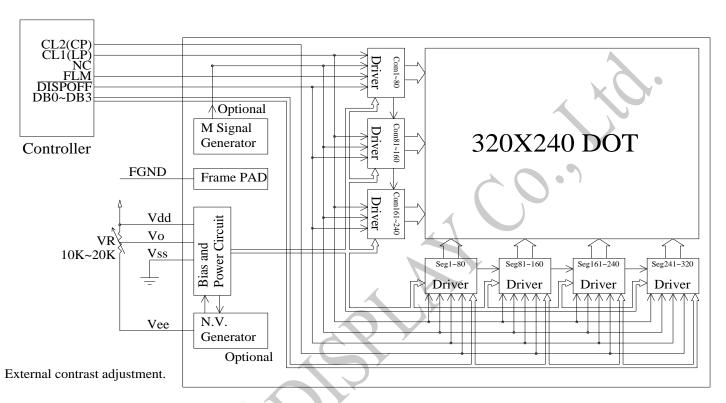


# **7.Interface Pin Function**

Pin No.	Symbol	Level	Description		
1	DB0	H/L	Data bus line		
2	DB1	H/L	Data bus line		
3	DB2	H/L	Data bus line		
4	DB3	H/L	Data bus line		
5	DISPOFF	H/L	H: Display ON, L: Display OFF		
6	FLM	H/L	Scan start-up signal		
7	NC		No Connection		
8	LP	H to L	Data latch pulse		
9	СР	H to L	Data shift pulse		
10	$V_{\mathrm{DD}}$		Power supply for Logic		
11	V <sub>SS</sub>	0V	Ground		
12	$V_{\rm EE}$	_	Negative voltage output		
13	Vo	(Variable)	Driving voltage for LCD		
14	FGND		Frame Ground		

# **8.Contour Drawing & Block Diagram**





#### First Data D3 D2 D1 D0 COM001 D3 D2 D1 D0 D3 D2 D1 D0 D3 D2 D1 D0 COM002 COM239 D3 D2 D1 D0 D3 D2 D1 D0 COM240 D3 D2 D1 D0 D3 D2 D1 D0 SEG002 SEG003 SEG004 SEG318 SEG319 SEG320 SEG317 SEG001

## 9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	<b>Environmental Test</b>		
Test Item	Content of Test	Test Condition	Not e
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= $\pm600$ V(contact), $\pm800$ v(air), RS= $330\Omega$ CS= $150$ pF 10 times	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

## **10.Backlight Information**

#### **Specification**

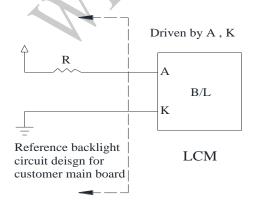
Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Supply Current	ILED	96	128	160	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	-
Reverse Voltage	VR	_	_	5	V	- X
Chromaticity	X	0.25	0.28	0.31	_	V-2 5V
Coordinates	Y	0.24	0.27	0.30	_	V=3.5V
Luminance (Without LCD)	IV	384	480	_	cd/m²	ILED=128mA
LED Life Time					<b>&gt;</b> ,	ILED=128mA
(For Reference	_	_	50K		Hr.	25℃,50-60%RH,
only)						(Note 1)
Color	White					

Note: A backlight driven by voltage will keep the drive current under the safe area (current between minimum and maximum).

If the B/L LED is driven by current only, the drive voltage cannot be considered as a reference value.

Note 1: Supply current minimum value is only for reference since LED brightness efficiency keeps enhancing. Current consumption becomes less and less to achieve the same luminance.

Note 2:50K hours is only an estimate for reference.



# 11.Inspection specification

No	Item			Criterion		AQL
01	Electrical Testing	Missing characte Display malfunc No function or n	er, dot or tion. o display. otion exce gle defec	eeds product specific		0.65
02	Black or white spots on LCD (display only)	2.1 White and bl three white or bla	ack spots	•	nm, no more than	2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type: $\Phi = (x + y)/2$ X  3.2 Line type: (4)	Y	Size $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ ing drawing)	Acceptable QTY Accept no dense 2 1 0 Acceptable Q TY	2.5
	3	→ L H		$W \le 0.02 \\ 0.02 < W \le 0.03$	Accept no dense  2  As round type	2.5
04	Polarizer bubbles	If bubbles are vis judge using black specifications, no to find, must che specify direction	k spot ot easy eck in	Size $\Phi$ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$	Acceptable Q TY Accept no dense 3 2 0	2.5
		specify direction	.,	Total Q TY	3	

No	Item		Criterion		AQL
05	Scratches	Follow NO.3 LCD blac	k spots, white spots, con	ntamination	
			Glass thickness a: LC	p thickness D side length	
		6.1 General glass chip: 6.1.1 Chip on panel sur	face and crack between p	panels:	
		z: Chip thickness	y: Chip width	x: Chip length	
	Chipped	Z≦1/2t	Not over viewing area	x ≤ 1/8a	
06	glass	$1/2t < z \leq 2t$	Not exceed 1/3k	x≤1/8a	2.5
		⊙ If there are 2 or more 6.1.2 Corner crack:	chips, x is total length o	of each chip.	
	A	z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x ≤ 1/8a	
		$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a	
		⊙ If there are 2 or more	chips, x is the total leng	gth of each chip.	

No	Item			Criteri	ion		AQL
		Symbols:					
		x: Chip length	y: Chip w	idth	z: Chi	p thickness	
		k: Seal width	t: Glass th	ickness	a: LCl	D side length	
		L: Electrode pad len	gth				
		6.2 Protrusion over	erminal:				
		6.2.1 Chip on electro	ode pad:				
06	Glass	y: Chip width y≤0.5mm 6.2.2 Non-conductiv		Chip leng $x \le 1/8a$	Z gth	z: Chip thickness $0 < z \le t$	2.5
		yı Chin width		Chin You	v4h	X Chin thickness	
		$y: Chip width$ $y \leq L$		Chip leng x≤1/8a	zuii	z: Chip thickness $0 < z \le t$	
						over 2/3 of the ITO must terminal specifications.	
						mer, the alignment mark not	
		be damaged.	oe near sea	ica by the	custoi	mer, the angillient mark not	
		6.2.3 Substrate protu	iberance and	d internal	crack.		
	_						
					width		
				<b>y</b> ≦	≦1/3L	$x \leq a$	
	M,	y X					

No	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
0.0	Backlight	8.2 Spots or scratched that appear when lit must be judged. Using	2.5
08	elements	LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5
		contamination.	
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the seal	2.5
		area on the PCB. And there should be no more than three places.	
		10.5 No oxidation or contamination PCB terminals.	
		10.6 Parts on PCB must be the same as on the production	2.5
10	PCB、COB	characteristic chart. There should be no wrong parts, missing	0.65
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product	
		characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	
		screw hold pad, make sure it is smoothed down.	2.5
		10.9 The Scraping testing standard for Copper Coating of PCB	
			2.5
		X	
		$X * Y \le 2mm^2$	
	AY	11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections, oxidation	2.5
11.4	Soldering	or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin	2.5
		(OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin	2.5
		must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

### **12.Material List of Components for**

### RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limi	ted value	is set up	accordi	ng to Ro	HS.					

- 2. Process for RoHS requirement : (only for RoHS inspection)
  - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
  - (2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

## 13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.



winstar <u>LCM Samp</u>		Feedback Sheet Page: 1
· Panel Specification:		
1. Panel Type:	Pass	□ NG ,
2. View Direction:	Pass	□ NG ,
3. Numbers of Dots:	Pass	□ NG ,
4. View Area:	Pass	□ NG ,
5. Active Area:	☐ Pass	□ NG ,
6. Operating Temperature:	☐ Pass	□ NG ,
7. Storage Temperature:	☐ Pass	□ NG ,
8. Others:		
• Mechanical Specification :		<b>Y</b>
1. PCB Size:	Pass	□ NG,
2. Frame Size:	Pass	□ NG ,
3. Materal of Frame:	Pass	□ NG ,
4. Connector Position:	Pass	□ NG,
5. Fix Hole Position:	☐ Pass	□ NG,
6. Backlight Position:	☐ Pass	□ NG ,
7. Thickness of PCB:	☐ Pass	□ NG ,
8. Height of Frame to PCB:	☐ Pass	□ NG ,
9. Height of Module:	Pass	□ NG ,
10. Others:	☐ Pass	□ NG ,
Relative Hole Size :		
1. Pitch of Connector:	☐ Pass	□ NG ,
2. Hole size of Connector:	☐ Pass	□ NG ,
3. Mounting Hole size:	☐ Pass	□ NG ,
4. Mounting Hole Type:	☐ Pass	□ NG ,
5. Others:	☐ Pass	□ NG ,
· Backlight Specification :		
1. B/L Type:	☐ Pass	☐ NG ,
2. B/L Color:	Pass	☐ NG ,
3. B/L Driving Voltage (Refere	ence for LED 7	
4. B/L Driving Current:	Pass	□ NG ,
5. Brightness of B/L:	Pass	□ NG ,
6. B/L Solder Method:	Pass	□ NG ,
7. Others:	Pass	□ NG ,

		Page: 2
• Electronic Characteristics	of Module:	
1. Input Voltage:	Pass	□ NG ,
2. Supply Current:	Pass	□ NG ,
3. Driving Voltage for LCD:	Pass	□ NG ,
4. Contrast for LCD:	Pass	□ NG ,
5. B/L Driving Method:	Pass	□ NG ,
Negative Voltage Output:	Pass	□ NG ,
. Interface Function:	Pass	□ NG ,
. LCD Uniformity:	Pass	□ NG ,
. ESD test:	Pass	□ NG,
. Others:	Pass	□ NG ,